

The Performance of the AstroPix Sensor: Bench Test and Beam Test

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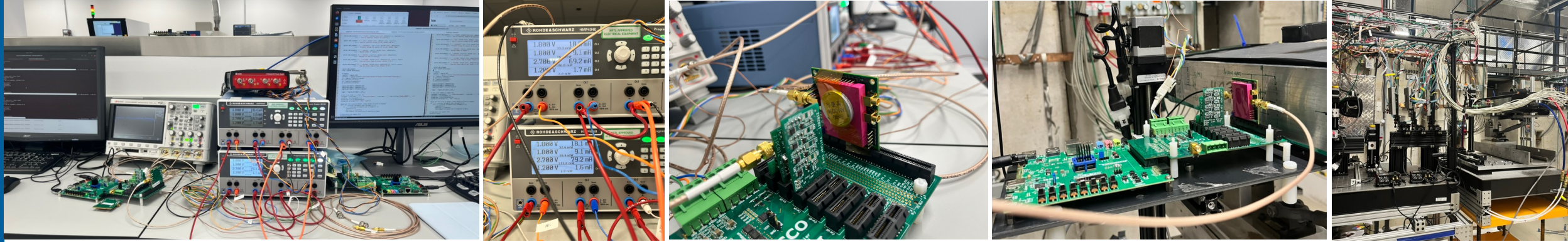
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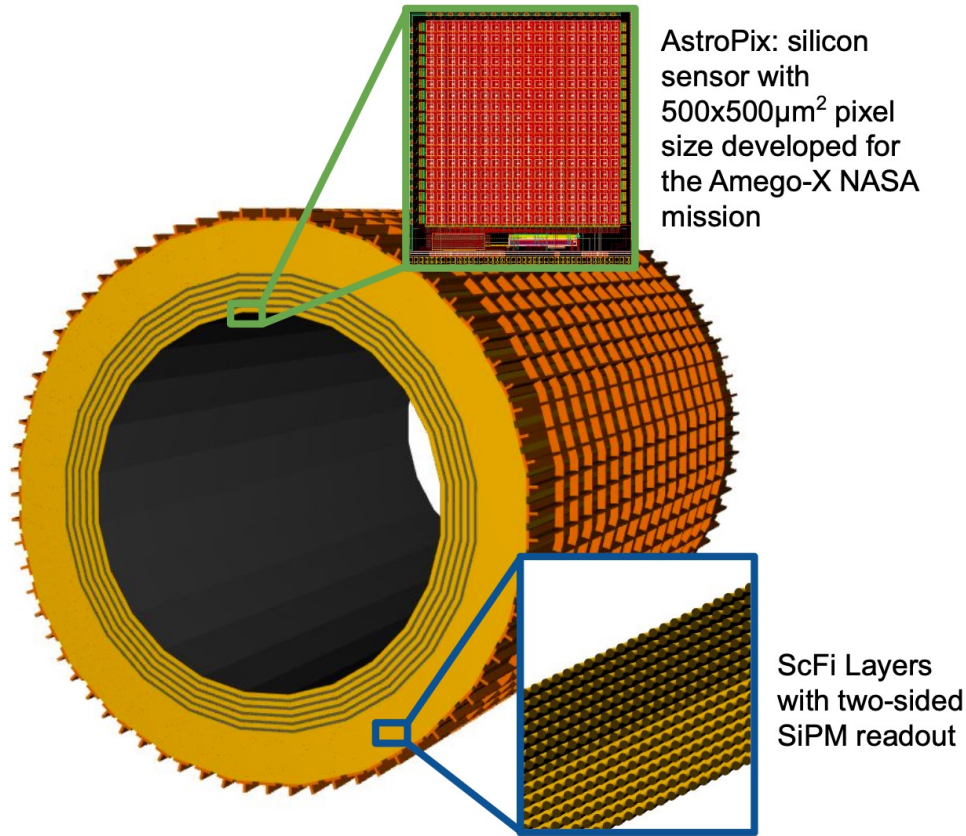


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- Astropix Sensor
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- Summary

Barrel Imaging Calorimeter in EIC detector



- The electromagnetic calorimeter is the main detector for electron-pion separation in the barrel region.
 - Detection of electrons/photons to measure energy and position
- Requirements for Barrel EM Calorimeter
 - Require moderate **energy resolution** $(7 - 10)\%/\sqrt{E} \oplus (1 - 3)\%$
 - Require **electron-pion separation up to 10^4** at low momenta in combination with other detectors
 - Discriminate between **π^0 decays and single γ up to ~ 10 GeV**
 - **Low energy photon** reconstruction ~ 100 MeV
- 4(+2) layers of Astropix sensors interleaved with the first 5 Pb/SciFi layers
- Followed by a **large section of Pb/SciFi section**
- Total radiation thickness $\sim 17.1 X_0$ at $\eta=0$
- Sampling fraction $\sim 10\%$

R&D goals for FY24

- Commissioning and characterizing a small Pb/SciFi calorimeter prototype, termed Baby BCAL, using mixed electron/pion and proton beams at the Fermilab Test Beam Facility (FTBF)
- Testing the first integration of the AstroPix v3 single chip with the Pb/SciFi system and the double layer using AstroPix v3 single chips

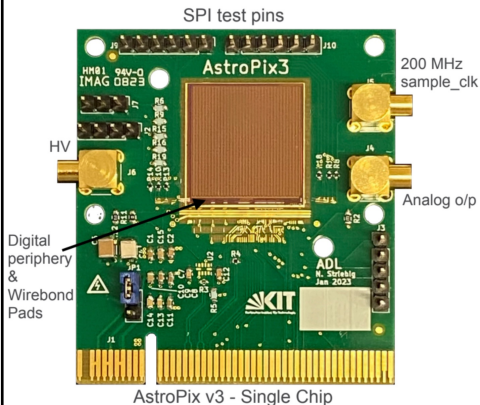
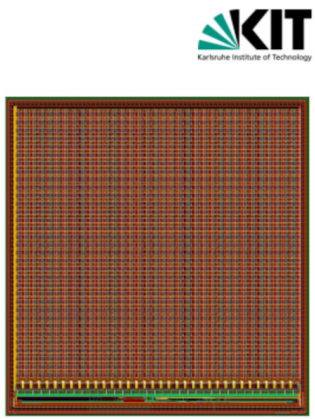
Astropix sensor: Introduction

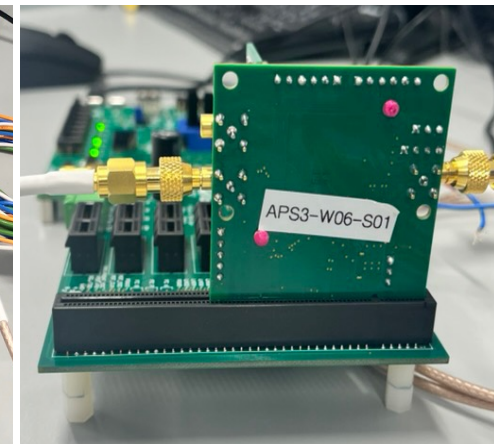
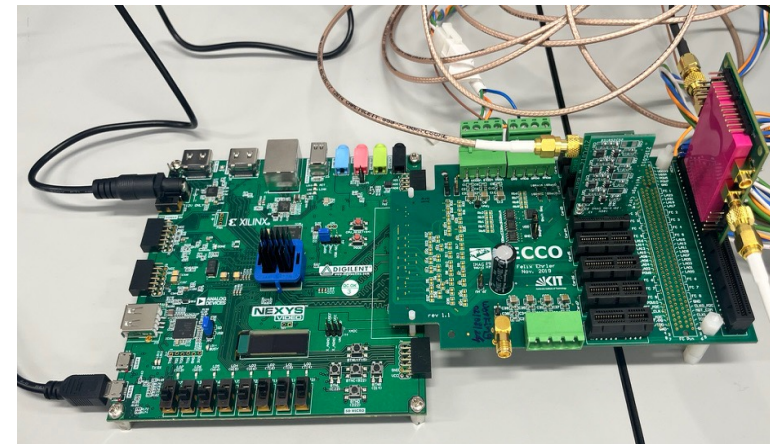
AstroPix R&D for BIC

- v3: Application in larger NASA payloads
 - Not final version for BIC
 - Single chip and quad chip: under test at ANL
- v4: Currently under test in NASA
- v5: Just submitted engineering run in mid June
 - For use in BIC
 - Similar to AstroPix v3

AstroPix v3 single chip

- $2 \times 2 \text{ cm}^2$ -size with 35×35 pixel matrix, $500 \mu\text{m} \times 500 \mu\text{m}$ pixel pitch, $720 \mu\text{m}$ thickness
- Very low power dissipation $< 1.5 \text{ mW/cm}^2$
- The good energy resolution ($< 10\%$ @ 60 keV)
- Timestamp clock: 2 MHz (500 ns), 8-bit (0-255)
- ToT (Time over Threshold) clock: 200 MHz (5 ns), 12-bit (0-4,096)
- 10-byte data frame per hit
 - Header including Layer ID
 - 5 Bytes of hit information from sensor (chip ID, pixel location, time stamp, Time over threshold)
 - 4 Bytes of FPGA timestamp

v3	v4	v5
 Labels: SPI test pins, AstroPix3, 200 MHz sample_clk, HV, Analog o/p, Digital periphery & Wirebond Pads, ADL, KIT, Jan 2023 AstroPix v3 - Single Chip • Full size $2 \times 2 \text{ cm}^2$ array • $500 \times 500 \mu\text{m}^2$ pixel pitch • 35×35 pixels	 Labels: KIT, AstroPix4, ADL, N. Simola, Jan 2023 • $1 \times 1 \text{ cm}^2$ array • $500 \times 500 \mu\text{m}^2$ pixel pitch • 16×13 pixels	 KIT Karlsruhe Institute of Technology • Full size $2 \times 2 \text{ cm}^2$ array • $500 \times 500 \mu\text{m}^2$ pixel pitch • 35×33 pixels

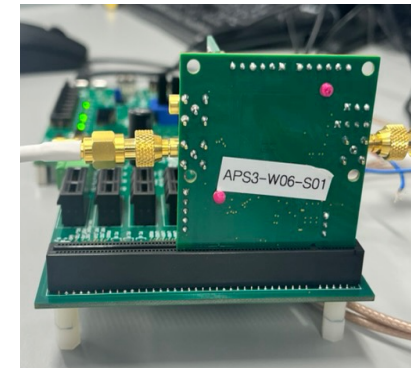
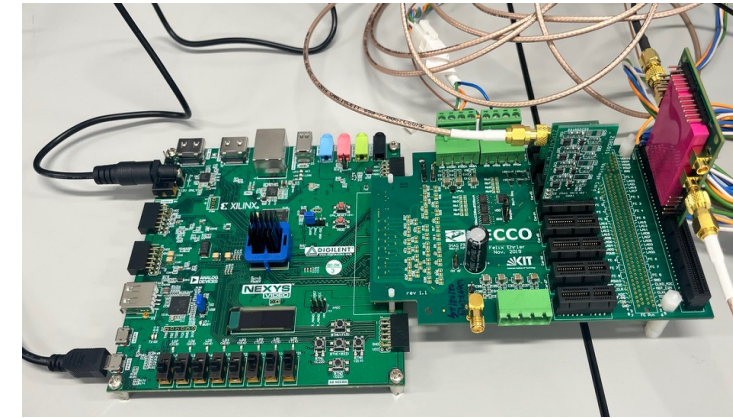
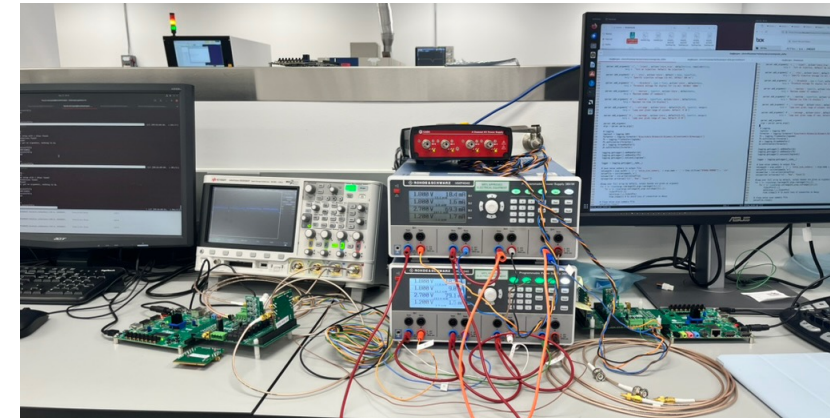


R&D Goal

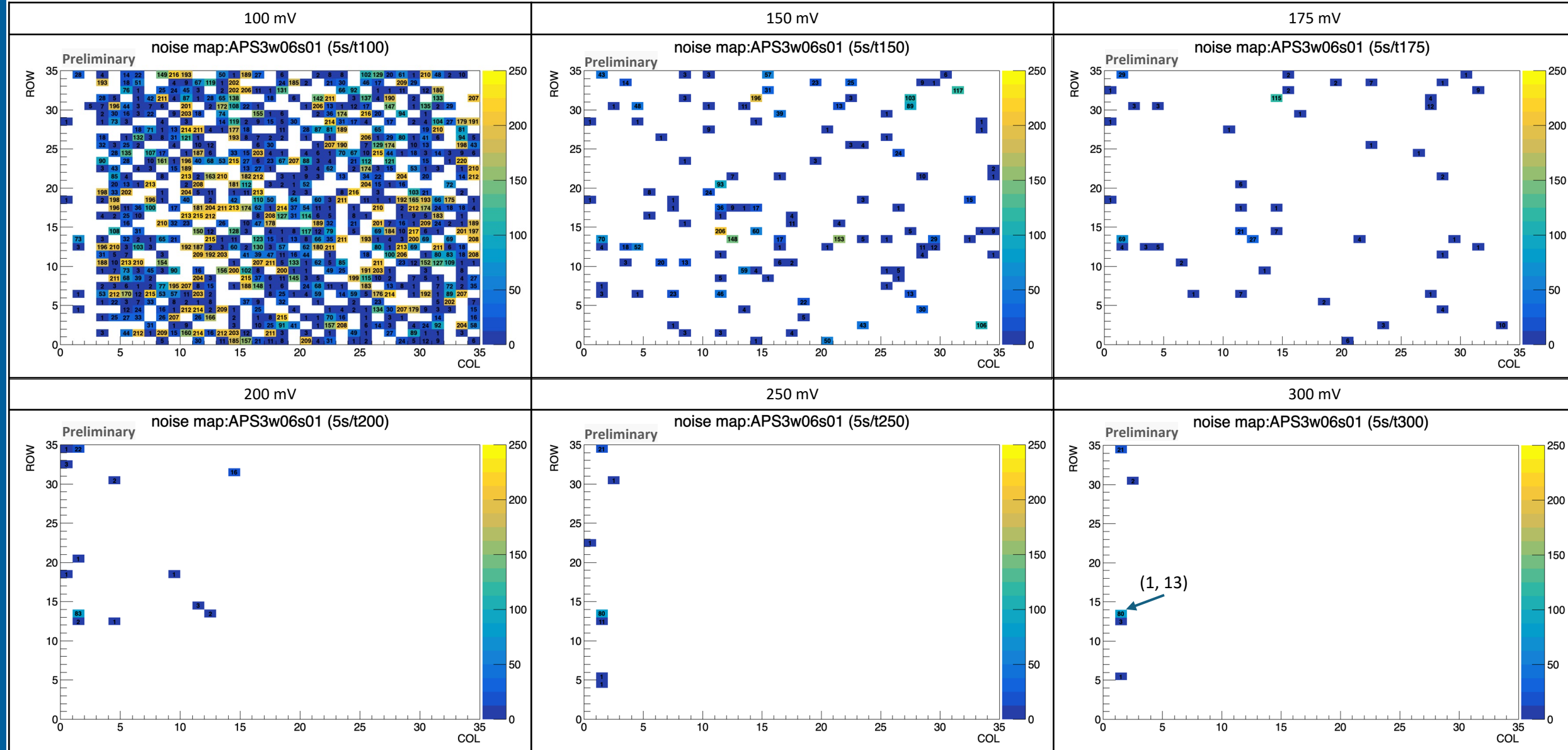
- M2: AstroPix chips prepared at the bench

1-1. Noise Scan with respect to threshold

- Used Astropix v3 single chips: APS3w06s01
- Bias voltage: - 150 V
- LV supply
 - Digital and analog: 1.8 V
 - Gecco board: 2.7 V
 - Amplifier: 1.2 V
- Time windows: 5 secs
- Threshold: 100, 150, 175, 200, 250, and 300 mV



Noise Scan with respect to threshold [100 mV – 300 mV]

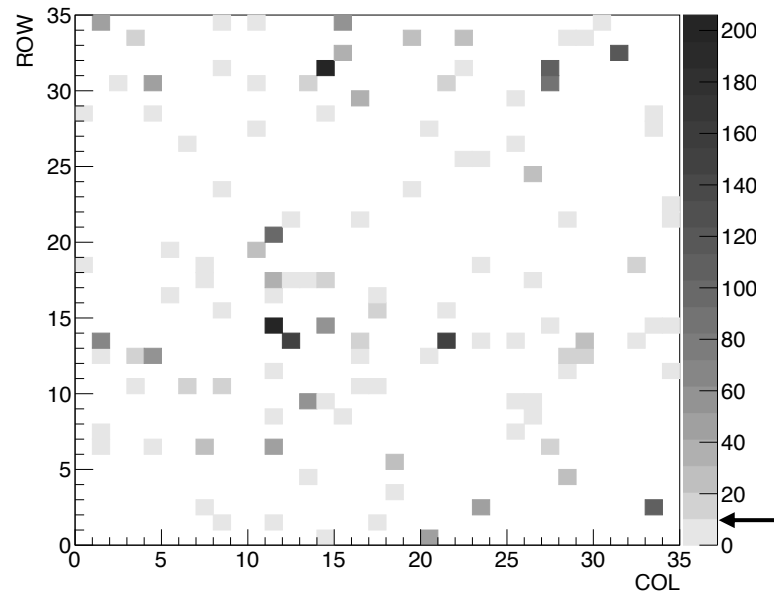


Noise Scan: Masked Pixels

- Disable pixel : Noise > 10
- Used 200 mV threshold for source test and beam test

$V_{th} = 150 \text{ mV}$

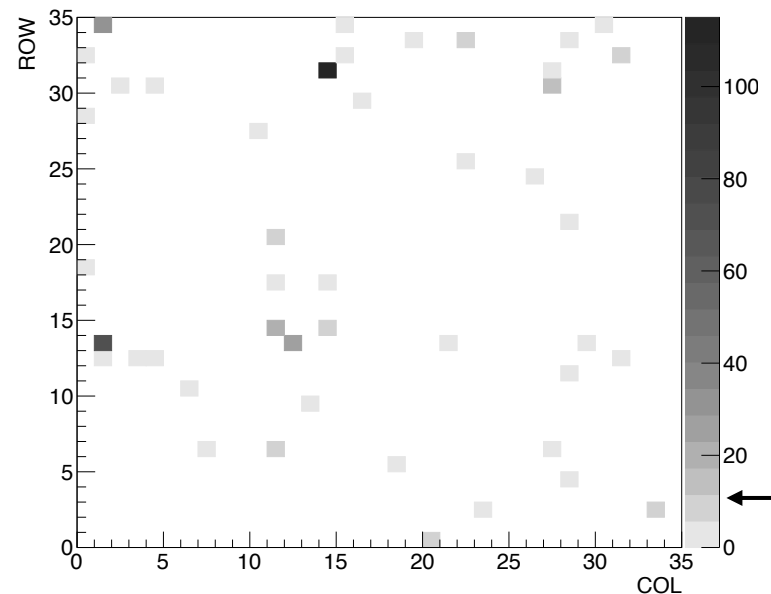
masked pixels: APS3w06s01 (5s/t150)



- Active pixels: ~ 96.5%
- 43/1225 pixels are disable.

$V_{th} = 175 \text{ mV}$

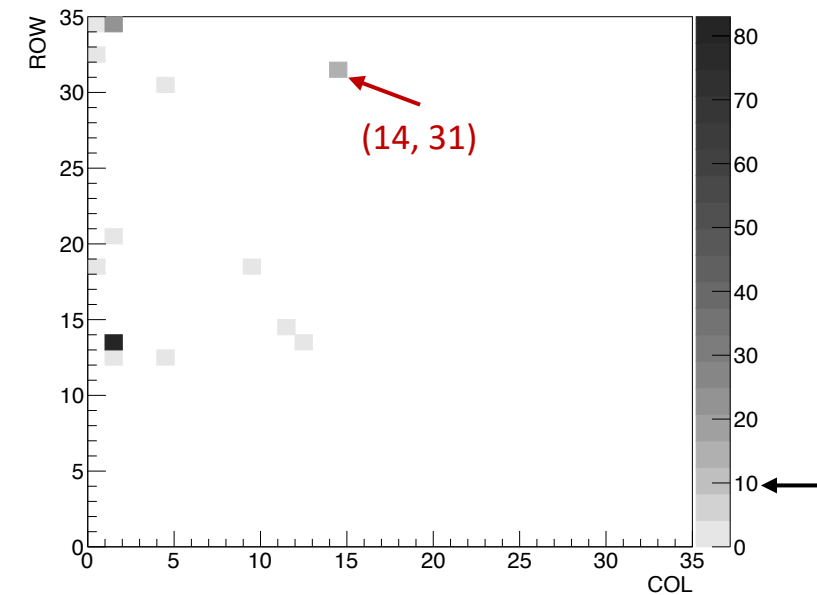
masked pixels: APS3w06s01 (5s/t175)



- Active pixels: ~ 99.5%
- 6/1225 pixels are disable.

$V_{th} = 200 \text{ mV}$

masked pixels: APS3w06s01 (5s/t200)



- Active pixels: ~ 99.8%
- 3/1225 pixels are disable.

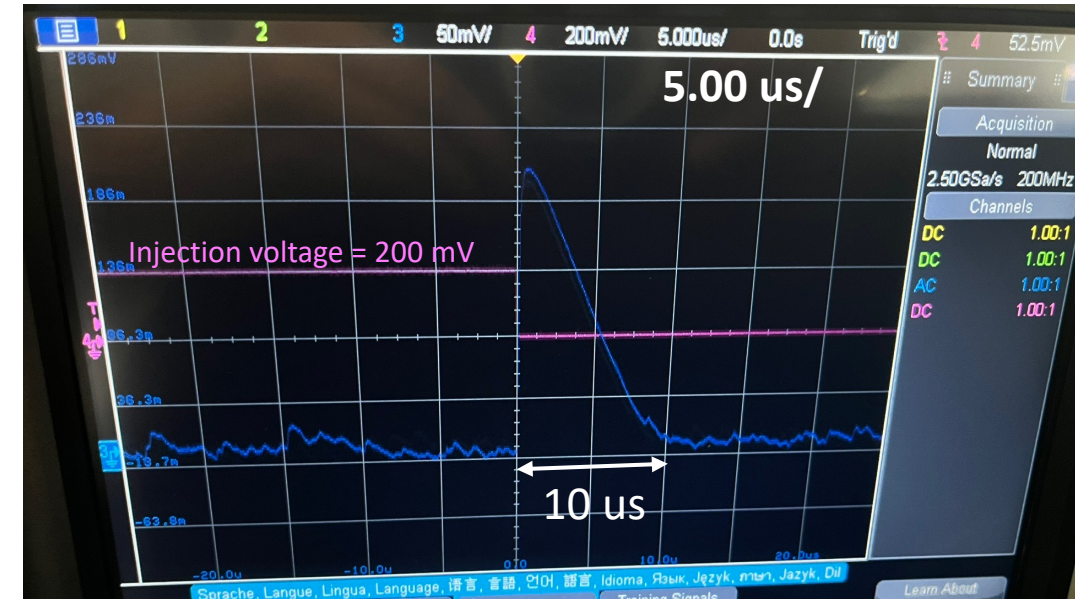
→ Masked noisy pixel (14, 31)

R&D Goal

- M2: AstroPix chips prepared at the bench

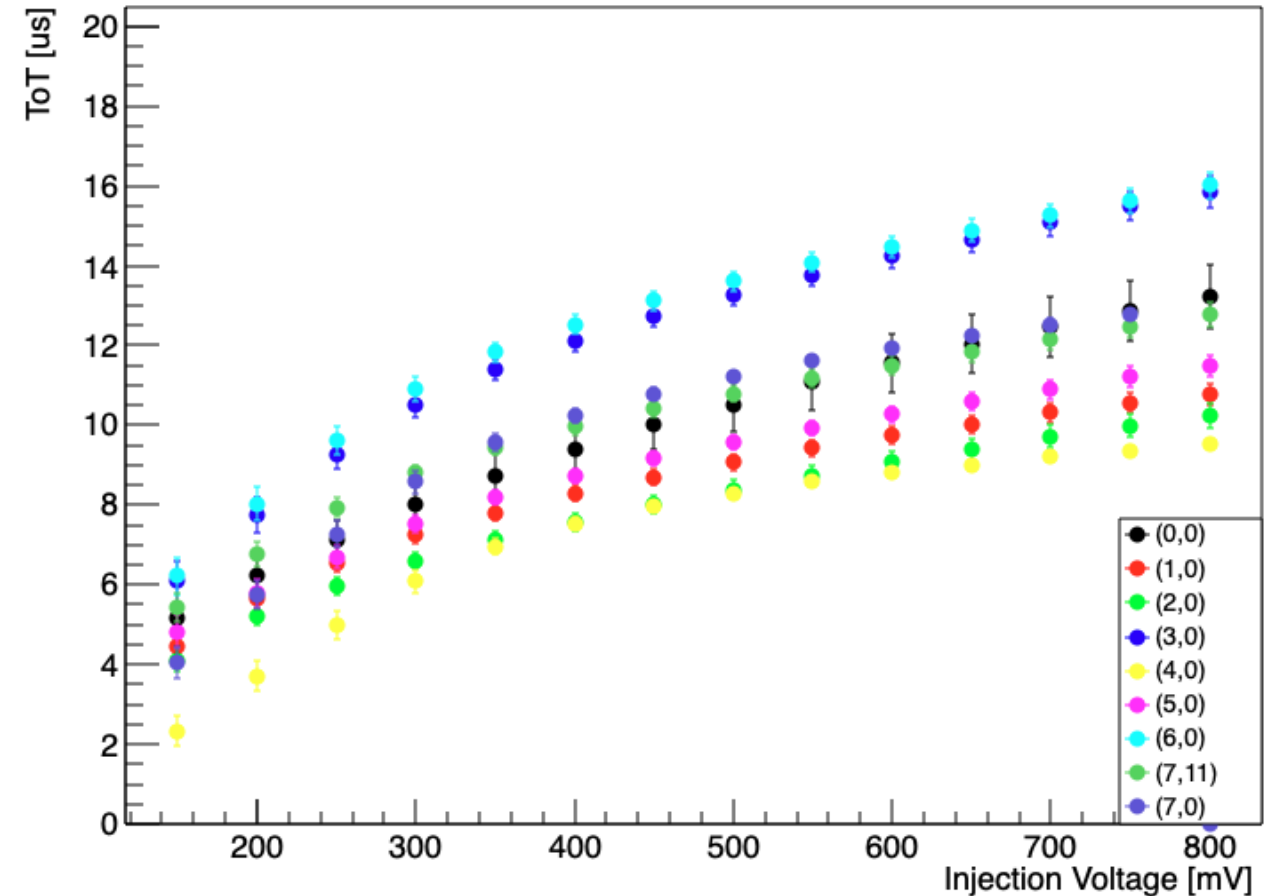
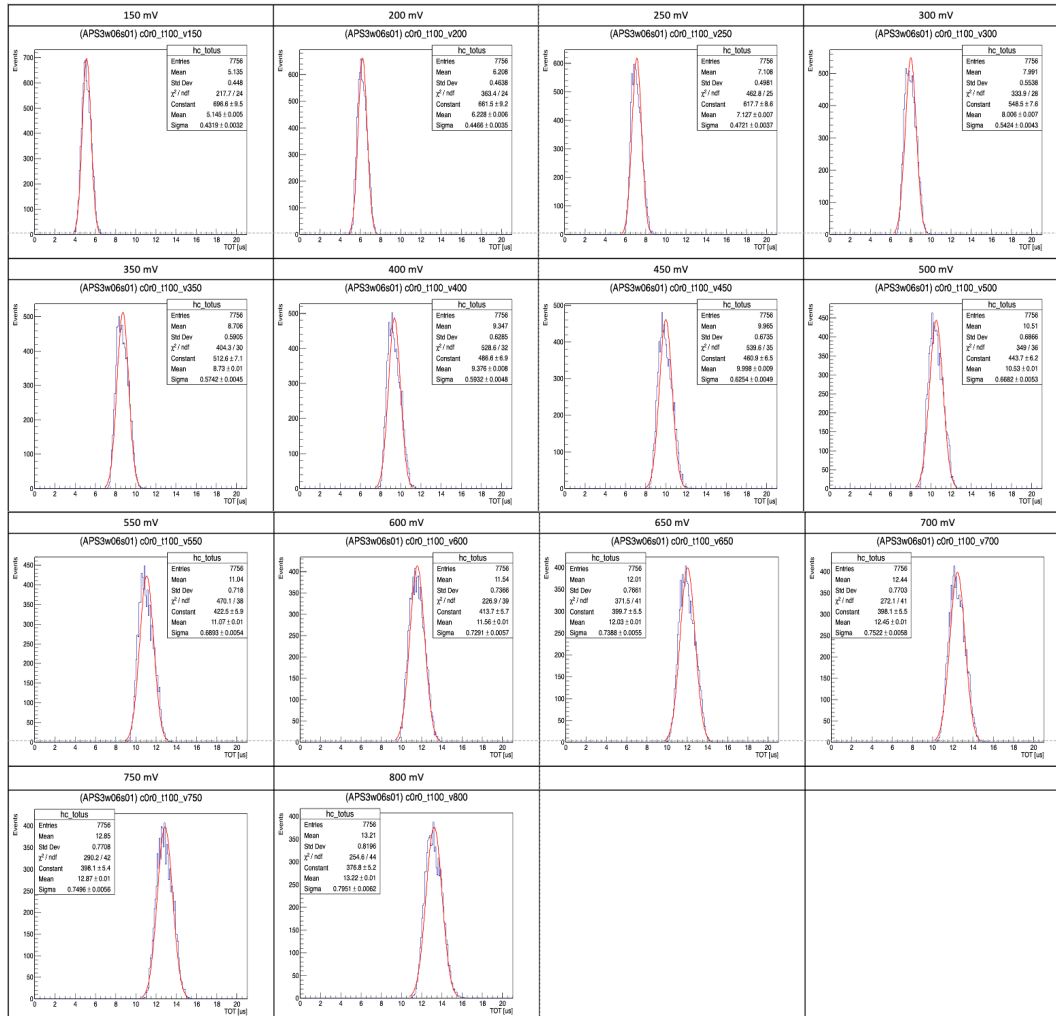
1-2. Injection Scan

- Used Astropix v3 single chips: APS3w06s01
- Bias voltage: - 150 V
- LV supply
 - Digital and analog: 1.8 V
 - Gecco board: 2.7 V
 - Amplifier: 1.2 V
- Threshold: 100 mV
- With respect to injection voltages at (COL #, ROW #)
 - Column (0, 1, 2, 3, 4, 5, 6) & Row 0
 - 150 mV – 800 mV in steps of 50 mV
 - Time windows: ~ 90 secs for 1k events



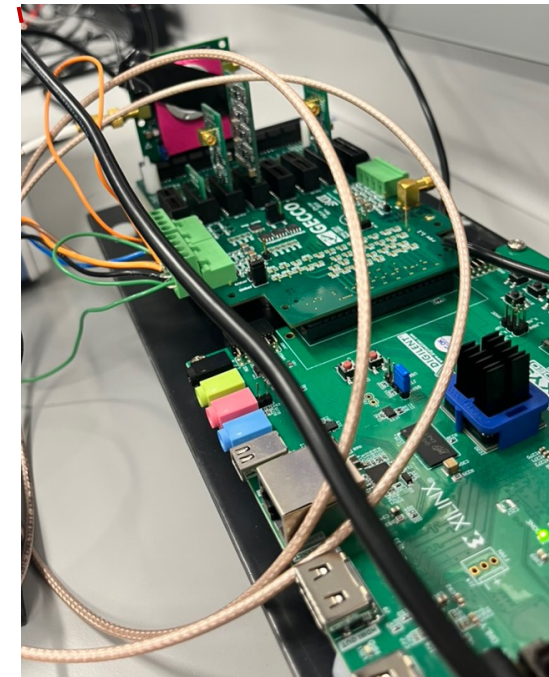
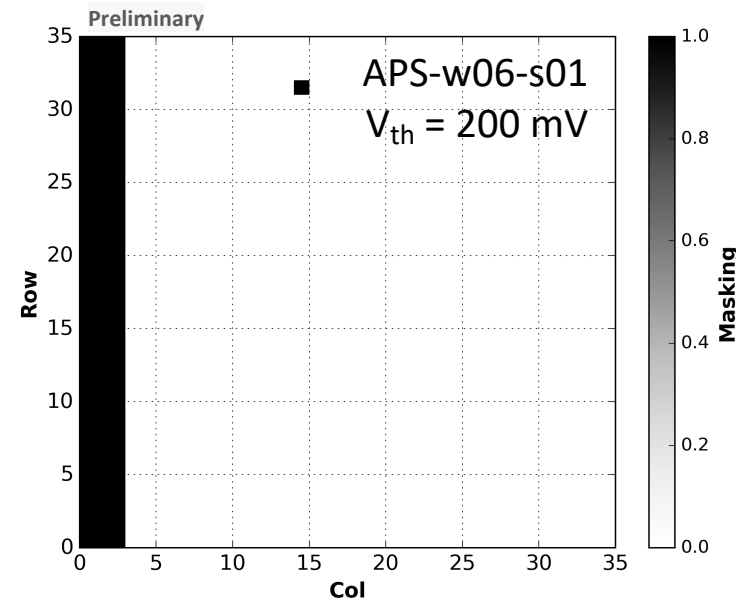
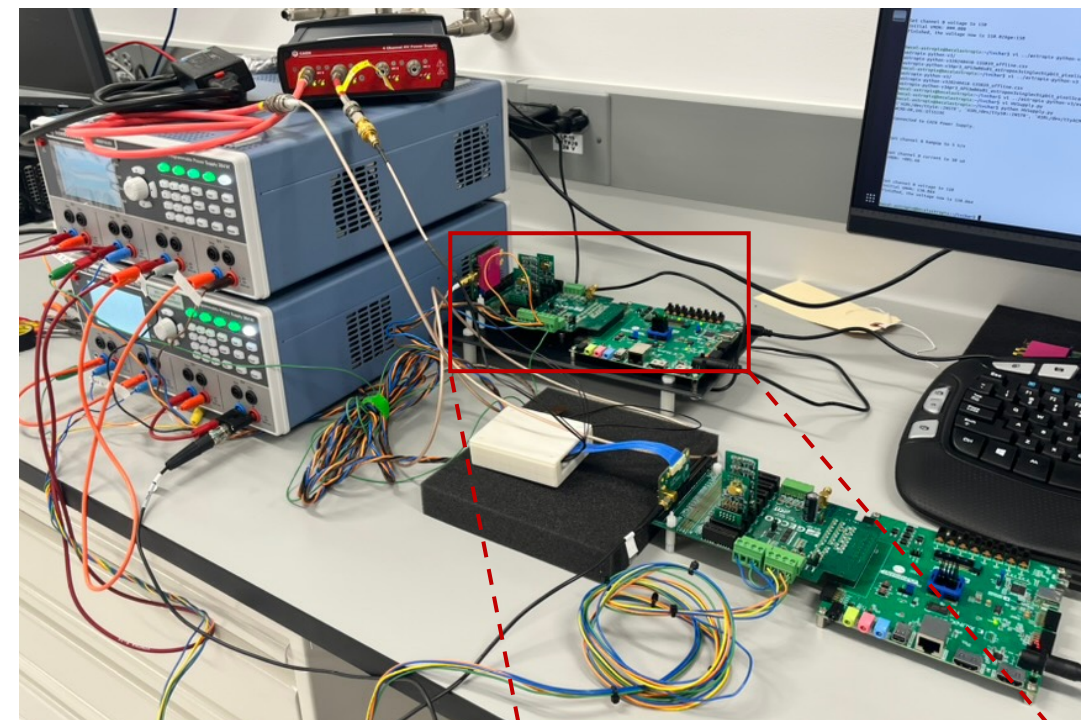
Injection Voltage vs ToT [us]

- Column (0, 1, 2, 3, 4, 5, 6) & Row 0
- ToT [us] as a function of injection voltages from 150 mV to 800 mV in steps of 50 mV.
- Fitting using gaussian function then mean and sigma values from fitting results are plotted.
- ToT spectra w.r.t various injection voltages at pixel (0, 0)
- ToT mean values as a function of various injection voltages



1-3. Source test using Am-241

- Used Astropix v3 single chips: APS3w06s01
- Bias voltage: - 150 V
- LV supply
 - Digital and analog: 1.8 V
 - Gecco board: 2.7 V
 - Amplifier: 1.2 V
- Used threshold = 200 mV
- Masked first three column pixels

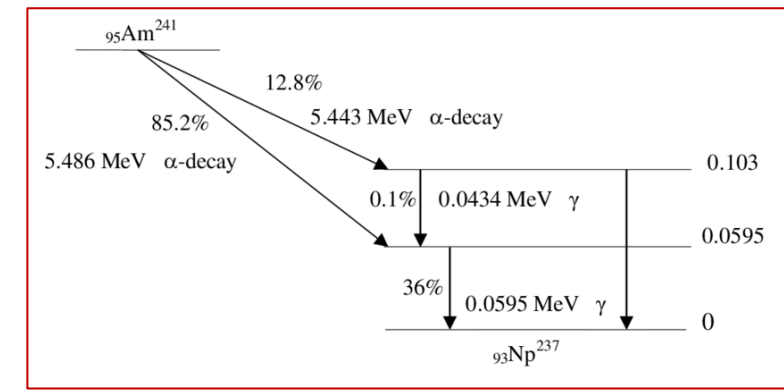


Am-241 Result: 32 × 35 pixels

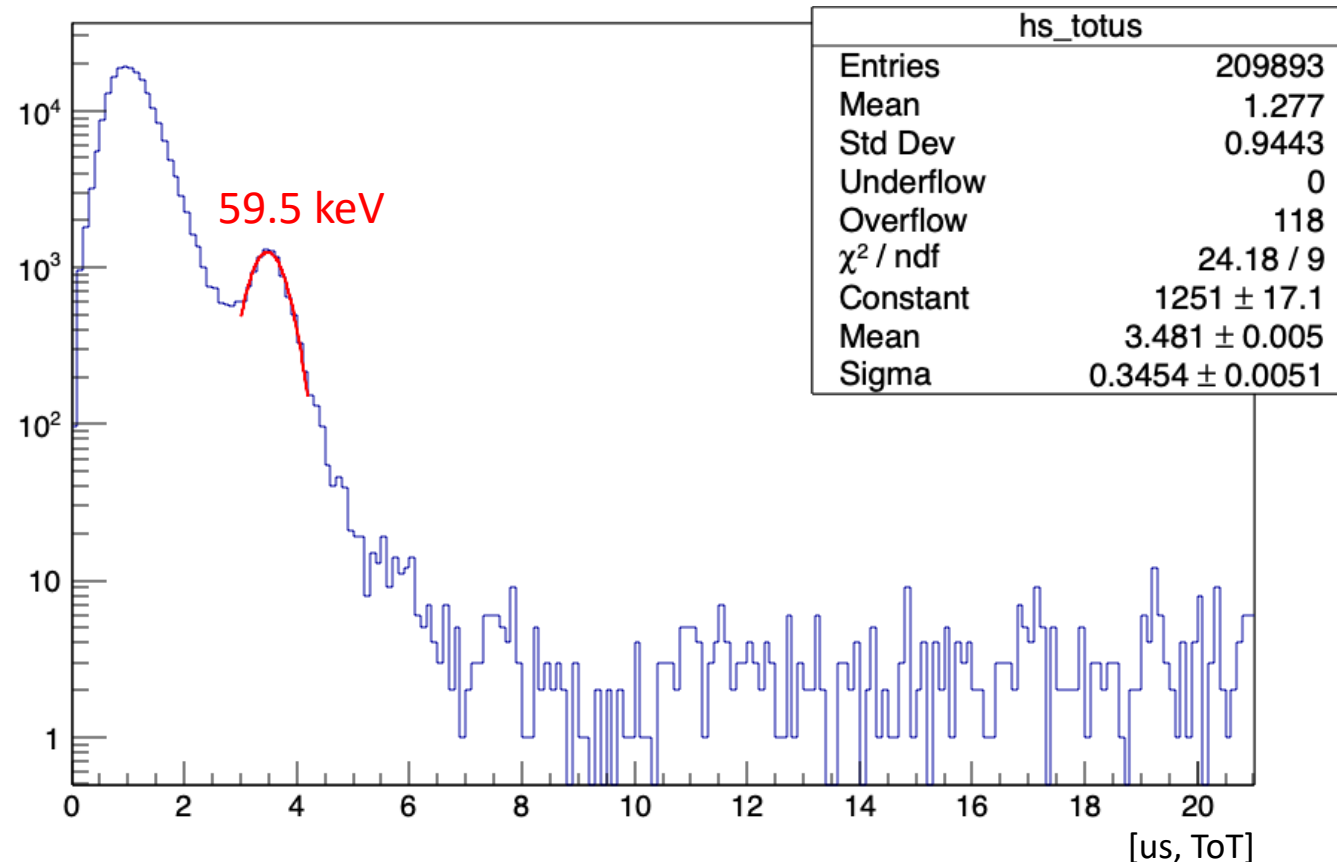
- Data-taking for 12 hours with 32 × 35 pixels (1,120 pixels)
- ToT distribution for all pixels after applying to scale factor (from proton result)
- Full peak, fitted with gaussian function

- A **calibration constant** is calculated:
 $59.5 \text{ [keV]} / 3.481 \text{ [us, ToT]} = 17.09 \text{ [keV]/[us, ToT]}$

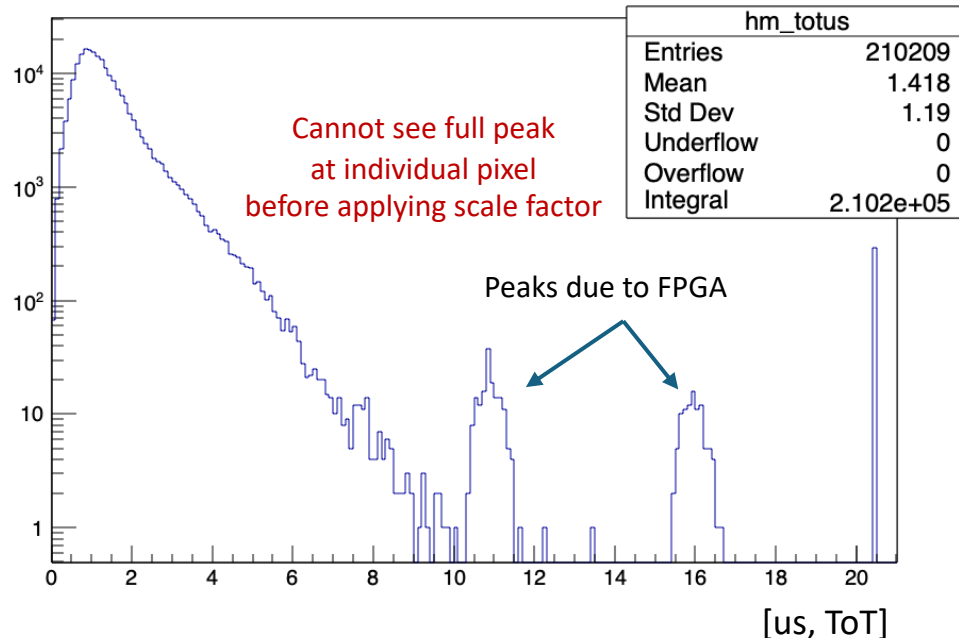
- $E_{\text{res}} \text{ (FWHM)} = 2.35 \times \frac{\text{Sigma}}{\text{Mean}} = 23.3 \% \text{ @ } 59.5 \text{ keV}$



ToT distribution of all pixels after applying scale factor



ToT distribution of all pixels **before** applying scale factor



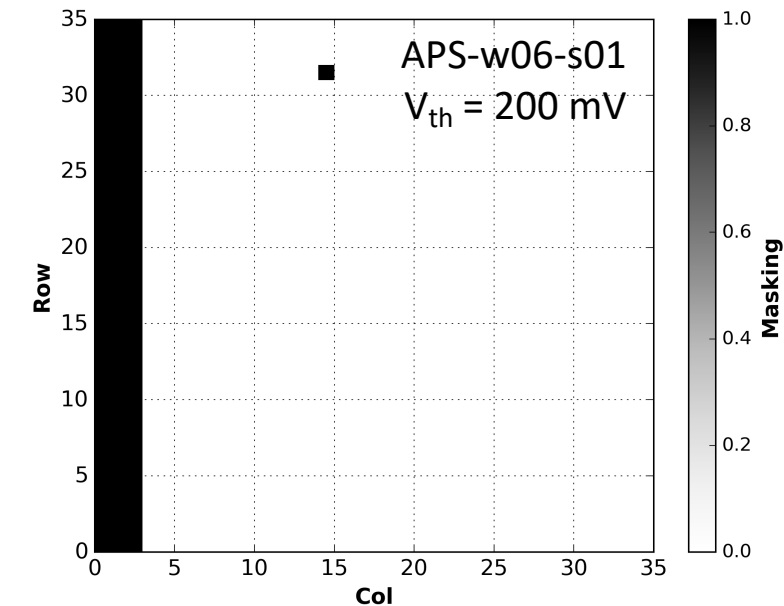
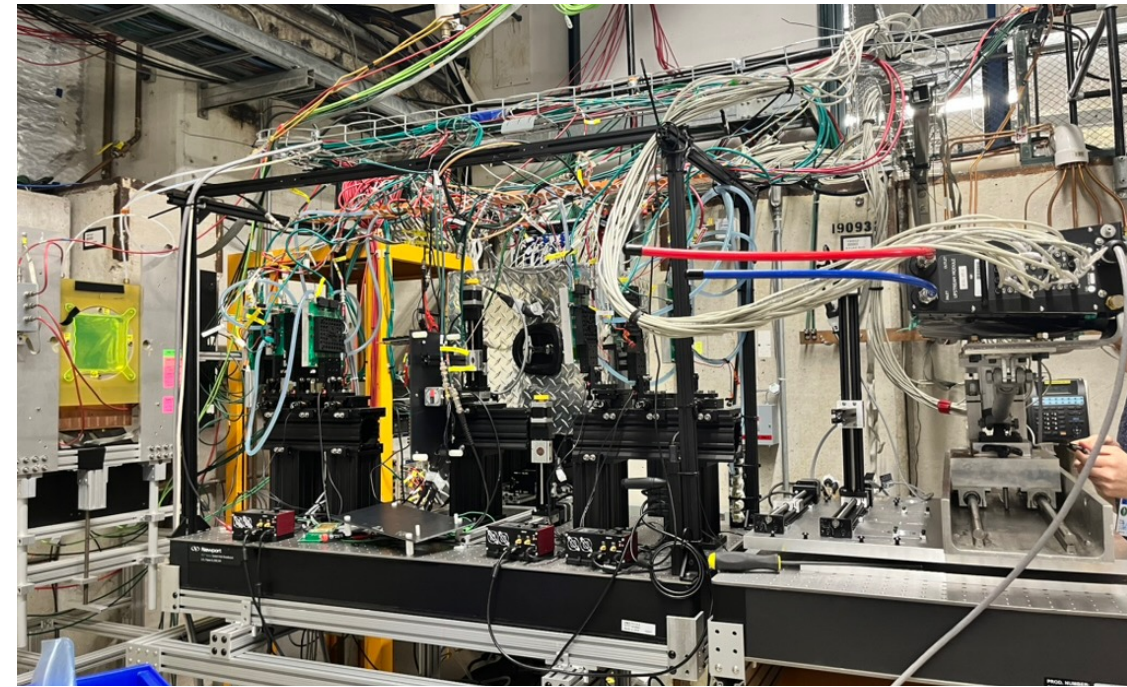
Beam Test R&D Goal

- M6: Integrated system commissioned with proton beam
 - Single AstroPix v3 chip with Baby BCal
 - Two AstroPix v3 chips daisy-chained

2. Beam Test at FNAL

On June 13-18

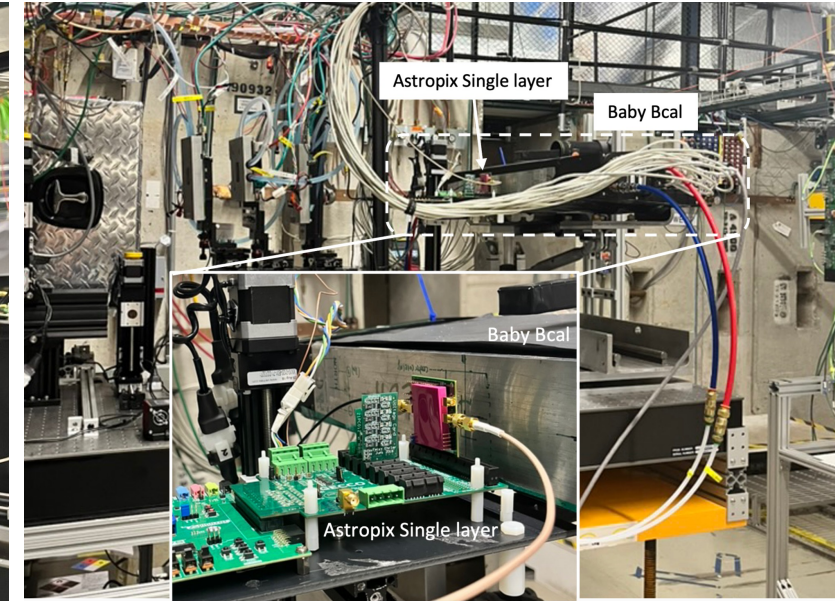
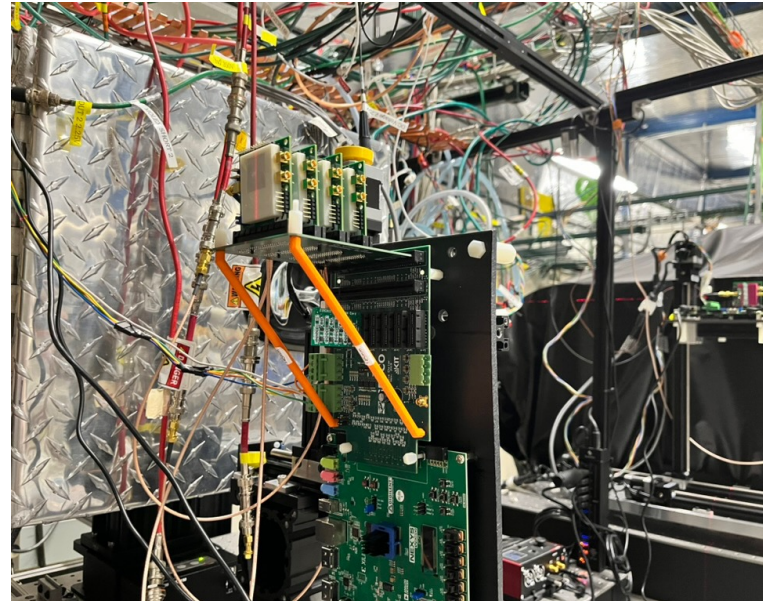
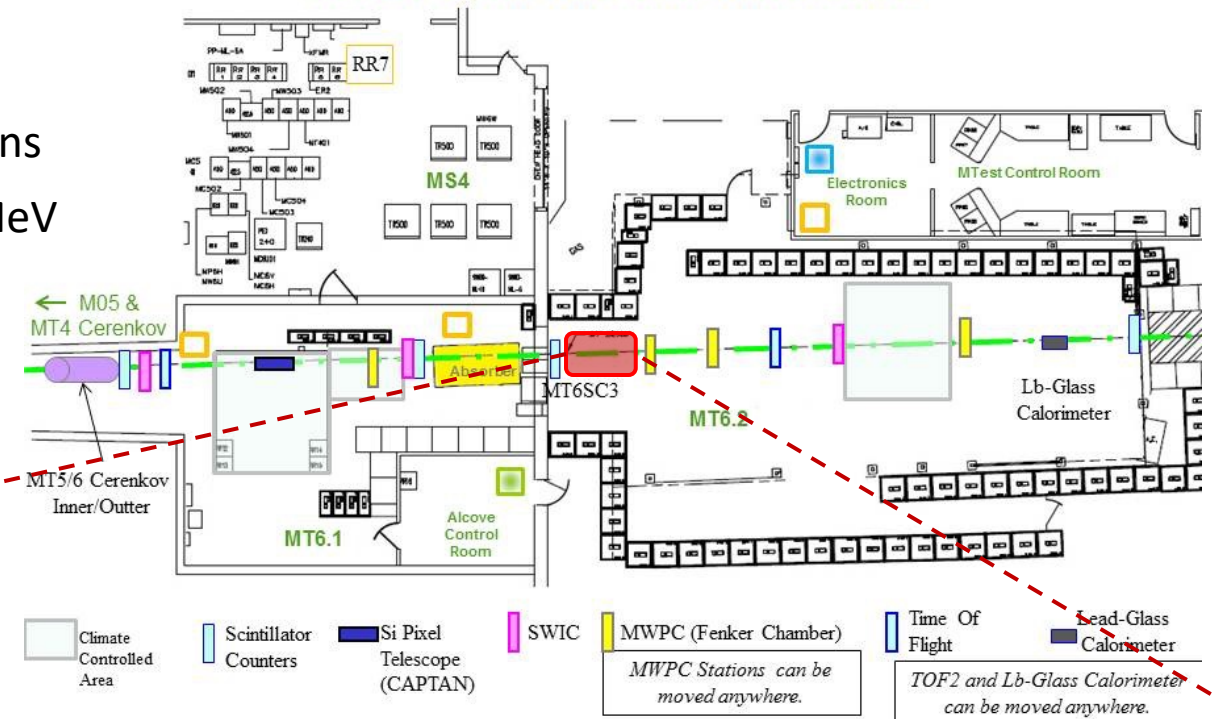
1. Single layer in front of Baby Bcal
 1. MIP response
 2. Astropix+Baby Bcal: coincident event
2. Double layer using two v3 single chips
 1. Coincident hits



Beam Test Setup @FNAL

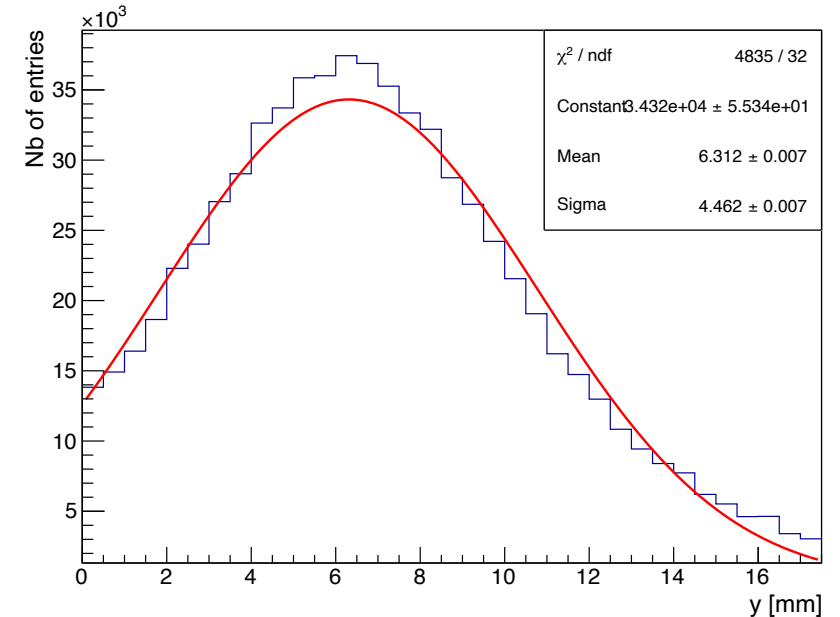
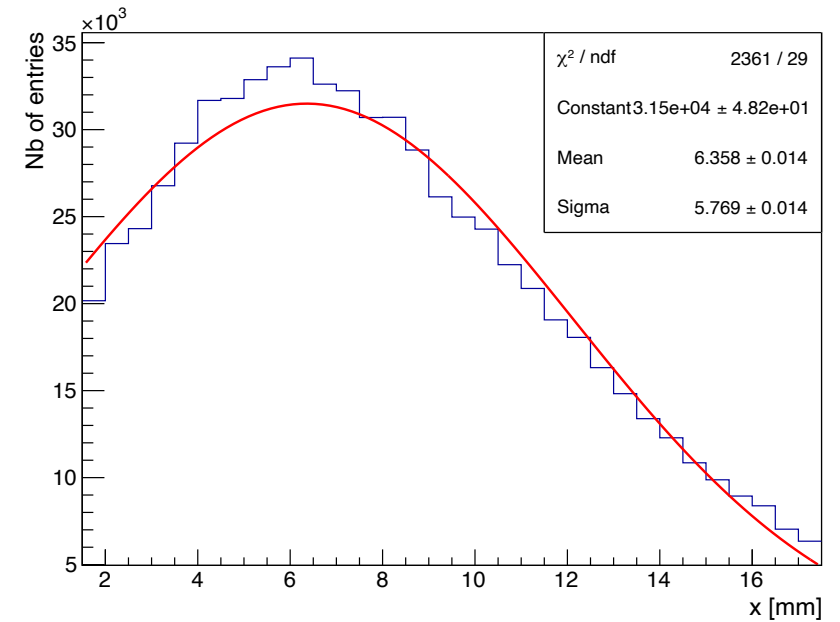
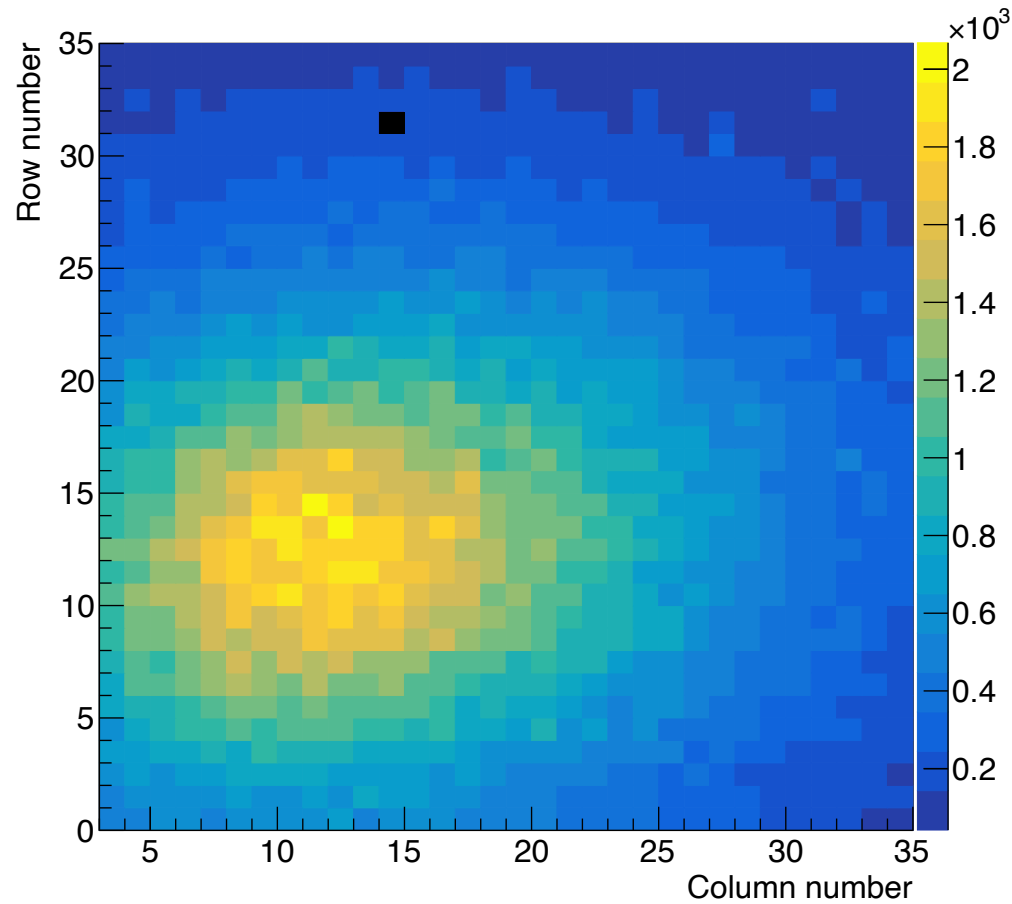
- 'Mtest' Beam line provides particles from 120 GeV protons to secondaries (electrons, muons, and pions) of ~ 200 MeV
 - Single 4.2 s long spill per every 60 seconds
- FNAL instrumentation system
 - Segmented Wire Ionization Chambers (SWICs);
2 mm wire spacing
 - Scintillator counter
 - Two Cherenkov detectors for PID

MTest Beam line Instrumentation



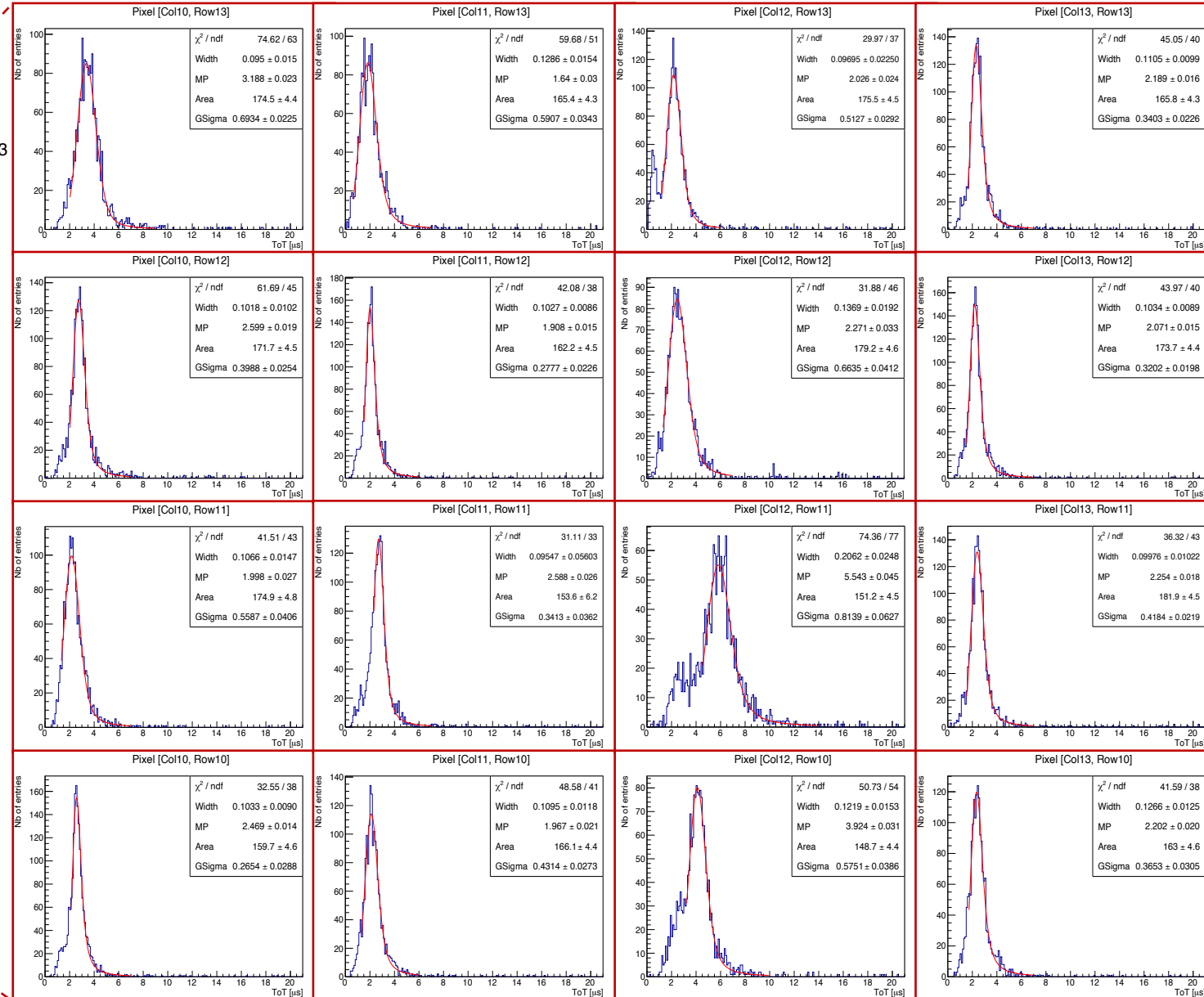
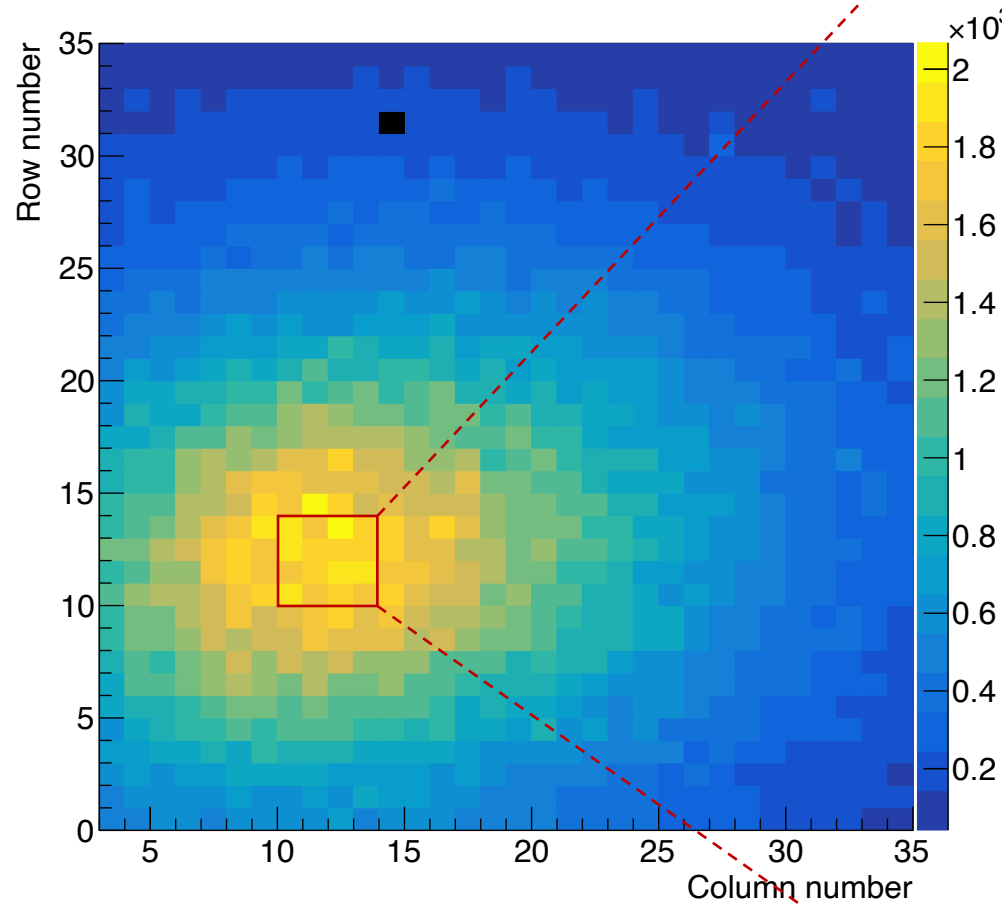
120 GeV Proton: Astropix, the beam profile

- The width of the beam profile is extracted from the beam hit map
- Position resolution: 500 μm
- $\sigma_x \times \sigma_y = 5.8 \text{ mm} \times 4.5 \text{ mm}$



120 GeV Proton: Astropix, ToT Distributions of 4 × 4 pixels

- Fit with landau convoluted with gaussian function on ToT distribution

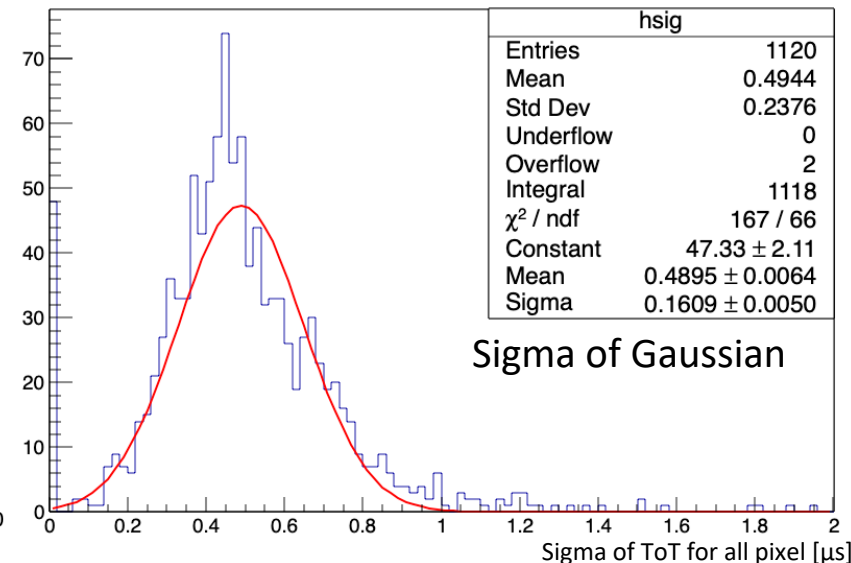
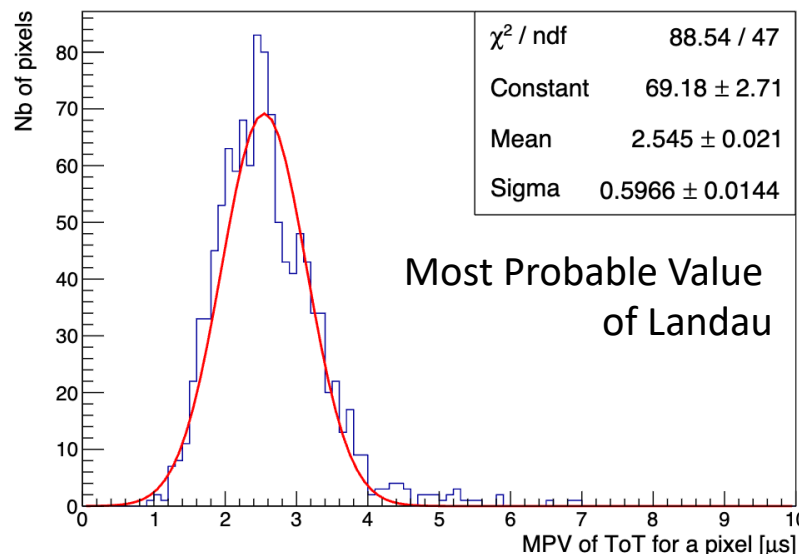


- 4 × 4
 - Col 10 – 13
 - Row 10 - 13

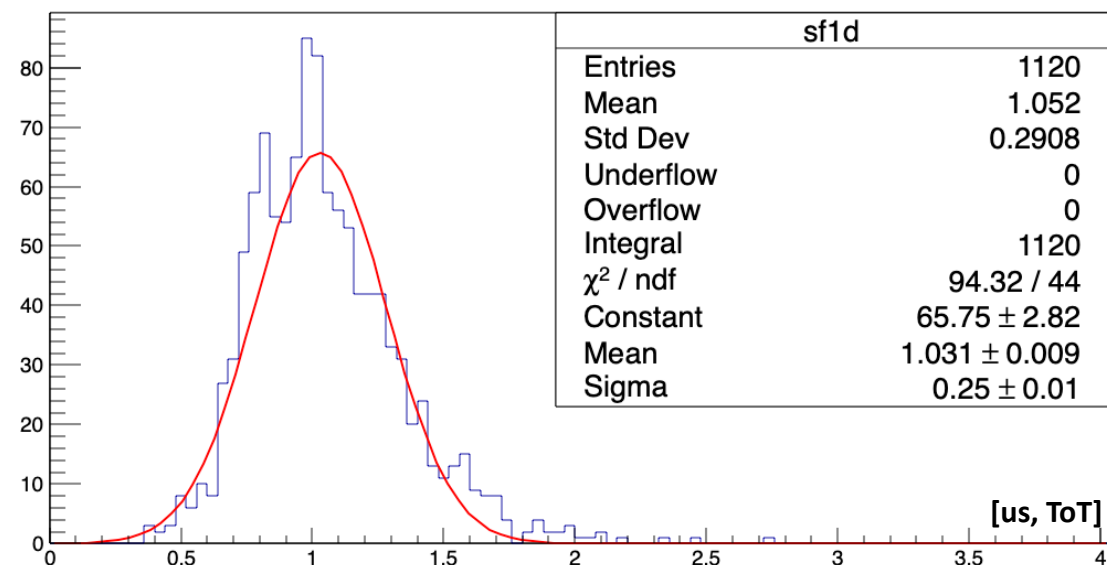
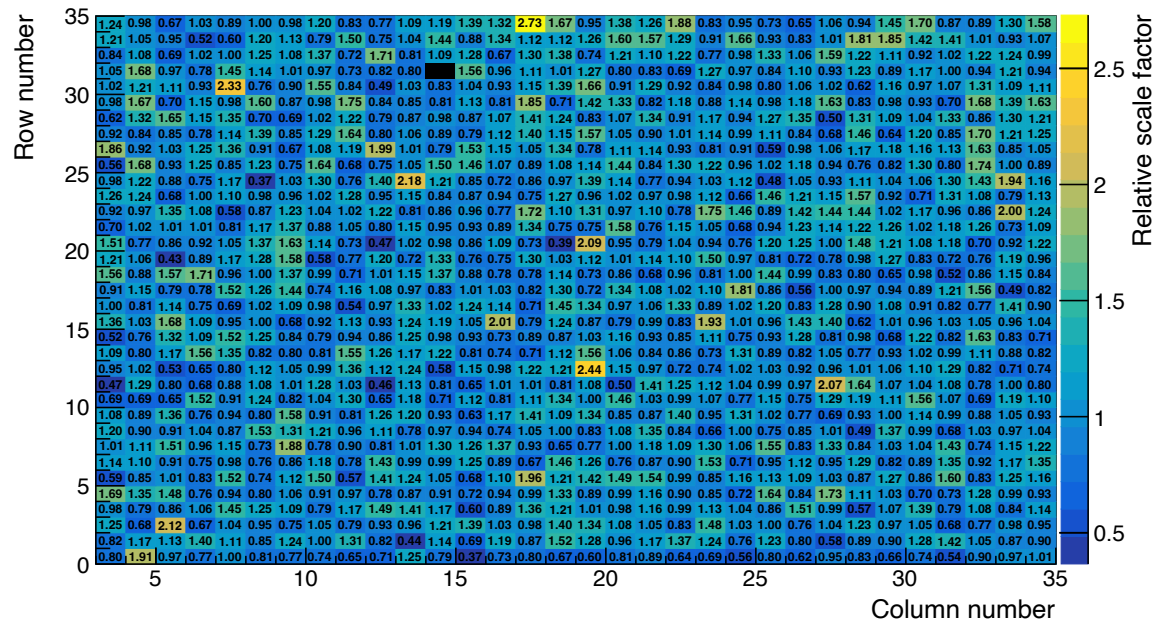
120 GeV Proton: Astropix, 32 × 35 pixels

- 32 × 35 (1,120 pixels)
 - Col 3 – 24
 - Row 0 - 35

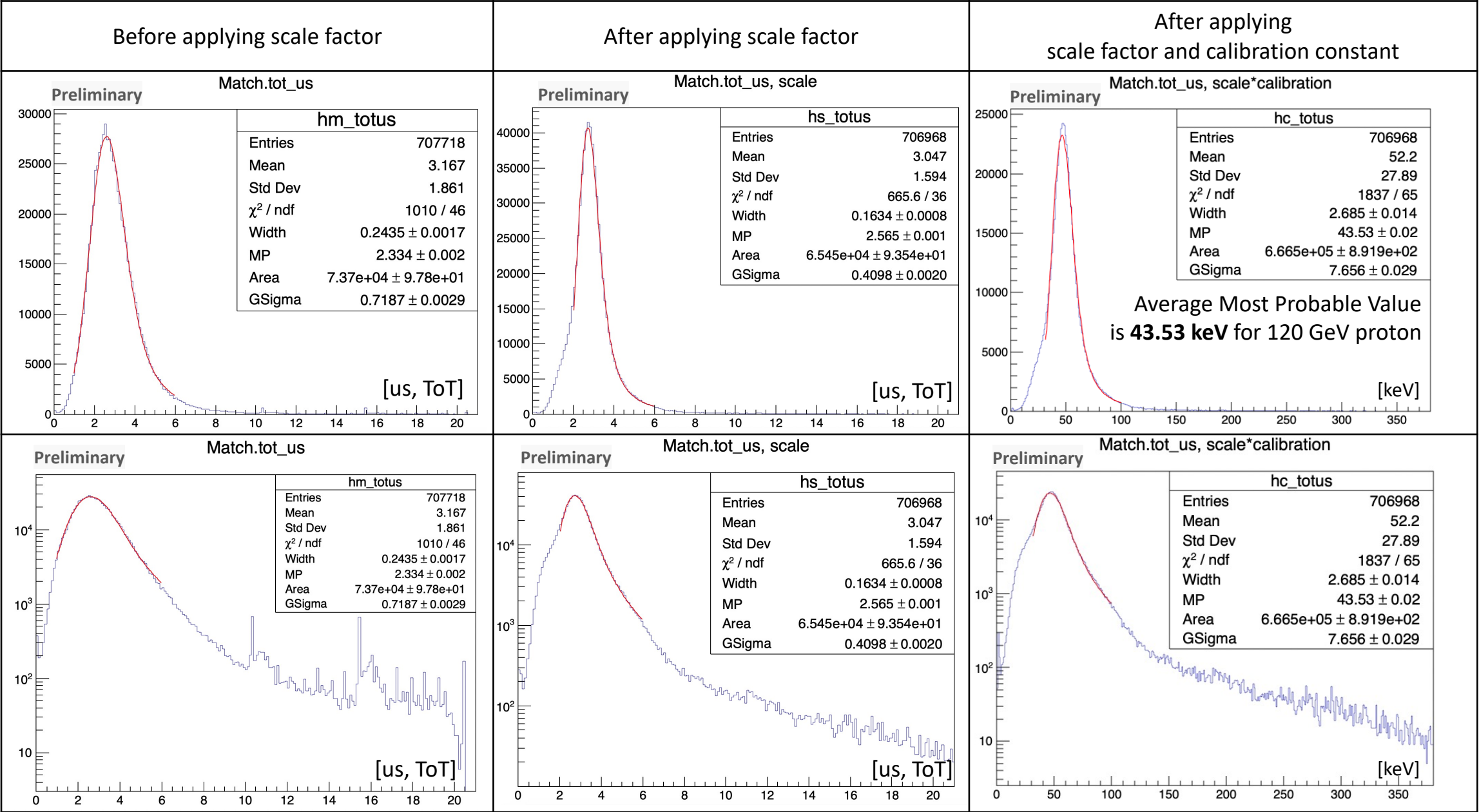
- Fit with landau convoluted with gaussian function on ToT distribution for all pixels



- Scale factor (sf), defined as mean of Most probable value for all pixels / Most probable value of each pixel

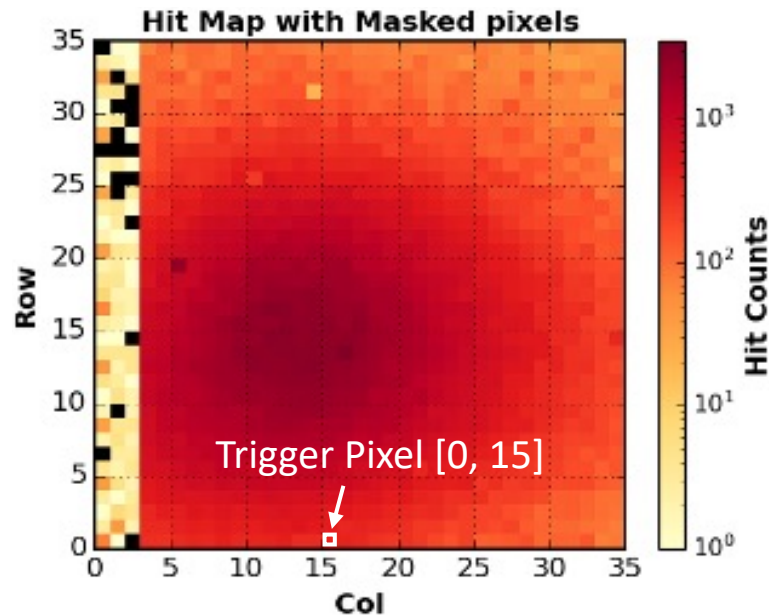
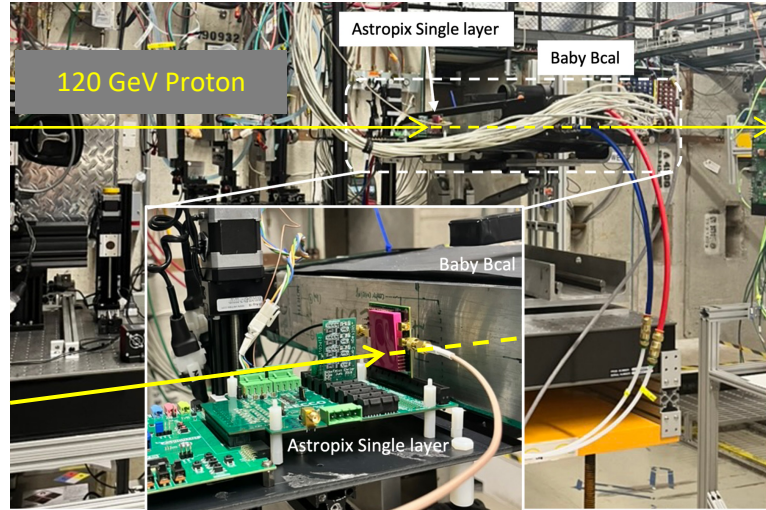


120 GeV Proton: Astropix, Energy Distribution of 32 × 35 pixels

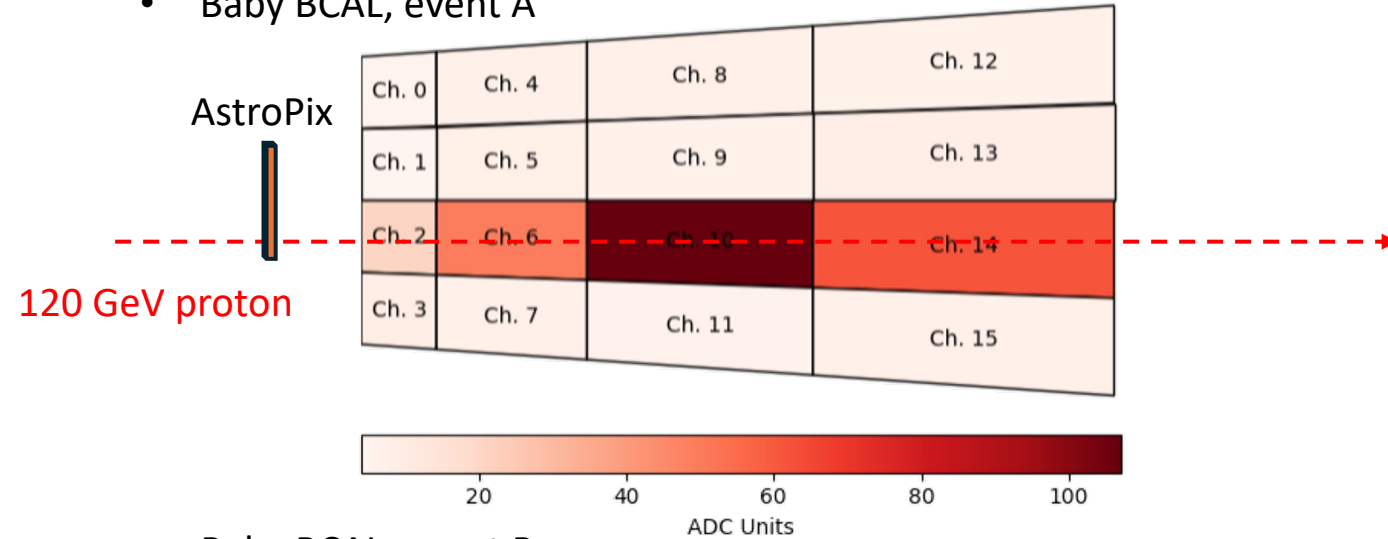


120 GeV Proton: Coincident Event Display of Baby BCAL and AstroPix

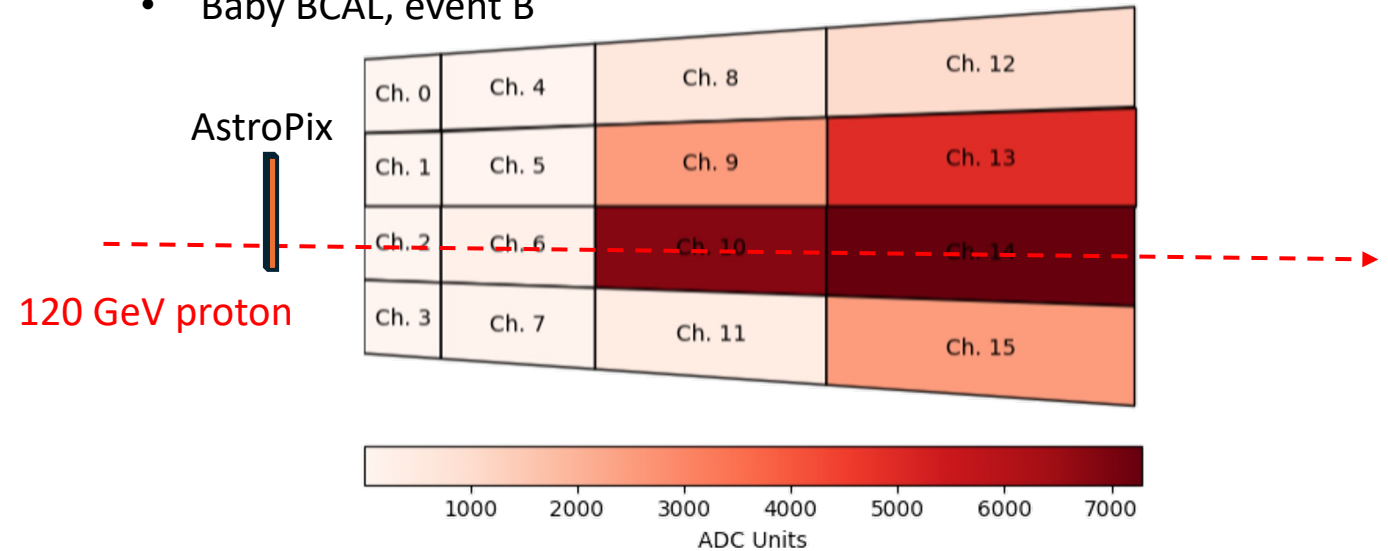
- Baby BCAL triggered by analog signal from [0, 15] pixel of Astropix



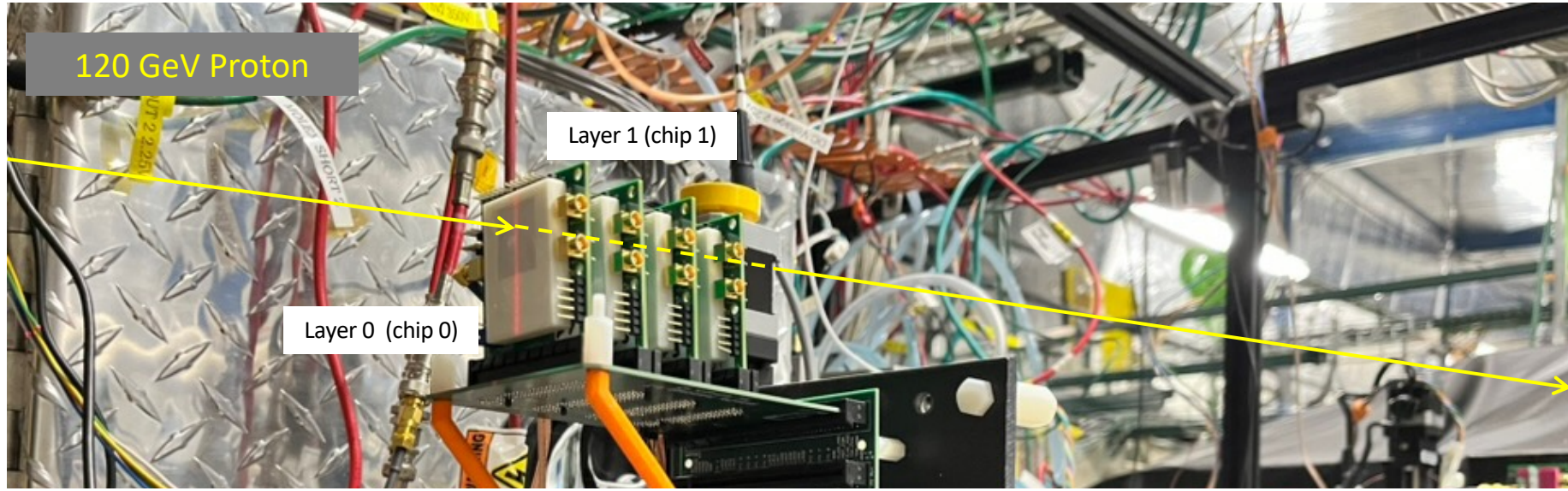
- Baby BCAL, event A



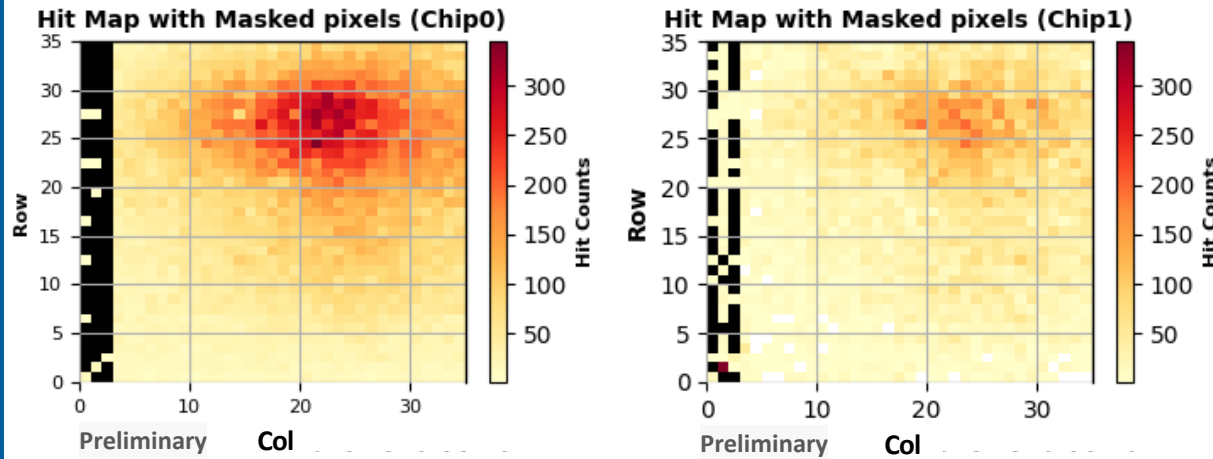
- Baby BCAL, event B



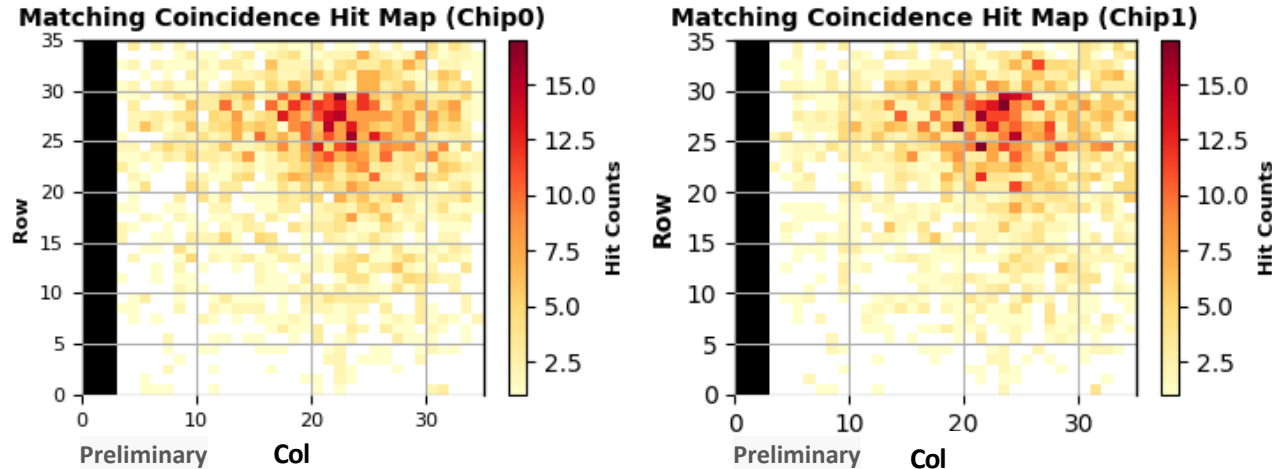
120 GeV Proton: Double Layer, Hit Map of Coincident Hit



- Matching hit using col&row information on same chip



- Matching coincident hit between chip0 and chip1



- Matching hits with time stamp < 2 and ToT error $< 10\%$

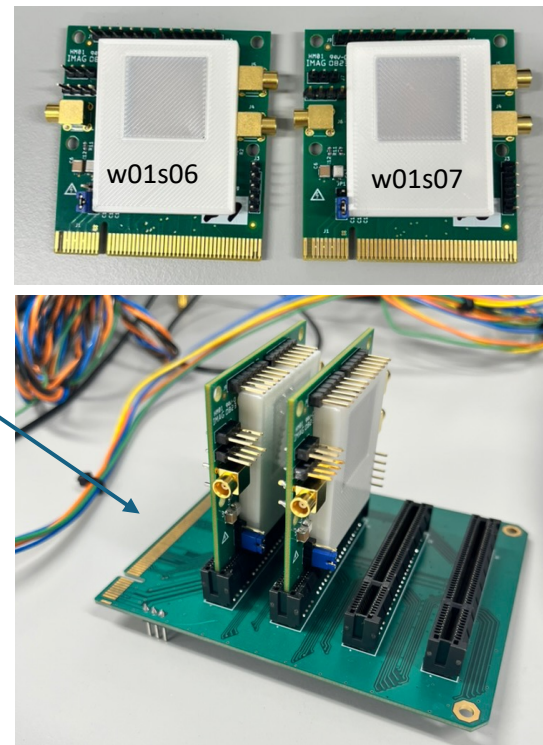
- Matching hits with location difference < 3 and time stamp difference < 5

Summary

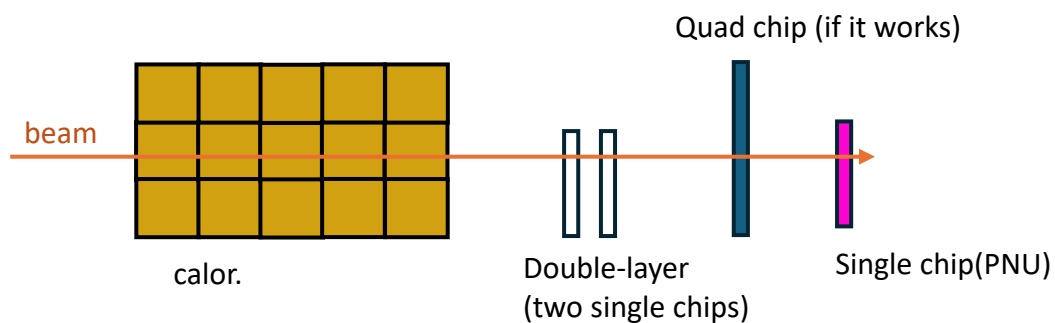
- The performance of Astropix v3 single chip is measured at ANL:
 - Noise scan: measured noisy pixels
 - Injection scan: measured a relation between injection voltage and individual pixel output
 - Source test: measured a calibration constant of 17.09 [keV]/[us, ToT]
- Using 120 GeV proton beam at FNAL
 - Astropix v3 single chip,
 - Measured beam position by hit map and average MIP deposited energy of 43.53 keV
→ Extract MIP response. Need to cross-check with simulation
 - Astropix and Baby BCAL,
 - Measured coincident hits between Astropix and Baby BCAL
→ Proof-of-concept tested in the beam
 - Double layer of two Astropix v3 single chips
 - Measured coincident hits between double layer
- Collaboration paper is in progress during this summer.

For Beam Test at CERN

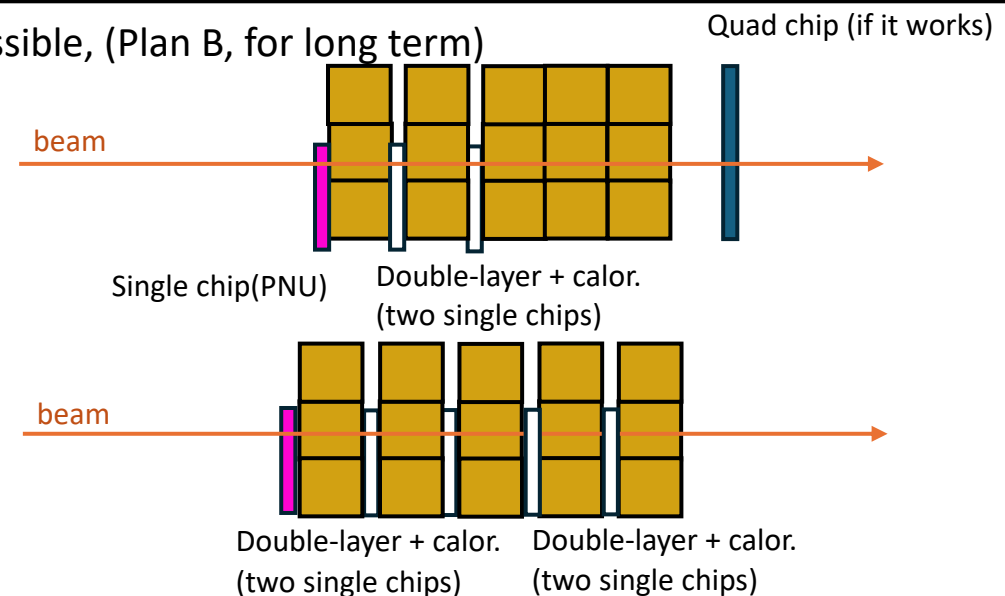
- Two GECCO+FPGA boards
- Two multi-layer boards
 - Confirmed that Double-layer is working.
- Three single chips
 - APS-W08s05
 - w01s07
 - w01s06
- One Quad chip: need to check operation
 - W06Q08
 - Only two chips on bottom are connected.



(Plan A)



If possible, (Plan B, for long term)



Thank you

